

Electronic Patent Application Fee Transmittal

Application Number:	10613924			
Filing Date:	03-Jul-2003			
Title of Invention:	Circuit materials, circuits, multi-layer circuits, and methods of manufacture thereof			
First Named Inventor:	Michael E. St. Lawrence			
Filer:	Leah Reimer/Laura Nolan			
Attorney Docket Number:	RGP-0116			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Submission- Information Disclosure Stmt	1806	1	180	180
Total in USD (\$)				180